

## NCE P-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE01P18K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications. It is ESD protested.

#### **General Features**

● V<sub>DS</sub> =-100V,I<sub>D</sub> =-18A

 $R_{DS(ON)}$  <100m $\Omega$  @  $V_{GS}$ =-10V (Typ:85m $\Omega$ )

 $R_{DS(ON)}$  <120m $\Omega$  @  $V_{GS}$ =-10V (Typ:95m $\Omega$ )

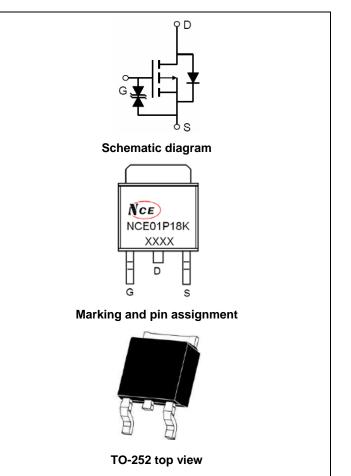
- Super high dense cell design
- Advanced trench process technology
- Reliable and rugged
- High density cell design for ultra low On-Resistance

#### **Application**

- Power management in notebook computer
- Portable equipment and battery powered systems

100% UIS TESTED!

100% ΔVds TESTED!



## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01P18K	NCE01P18K	TO-252-2L	-	-	-

## Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	-18	А
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	-12	А
Pulsed Drain Current	I <sub>DM</sub>	-100	А
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	170	mJ
Maximum Power Dissipation	P <sub>D</sub>	70	W
Derating factor		0.56	W/°C
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 175	$^{\circ}$





## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	R <sub>eJc</sub>	1.79	°C/W	Ī
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## Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	•		•				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-100	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-100V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±20	μA	
On Characteristics (Note 3)	·						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1	-1.9	-3	V	
Drain-Source On-State Resistance	В	V <sub>GS</sub> =-10V, I <sub>D</sub> =-16A	-	85	100	0	
Diani-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-16A		95	120	mΩ	
Gate resistance	R <sub>G</sub>	F=1.0MHz	-	4.5	-	Ω	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =-50V,I <sub>D</sub> =-10A	5	-	-	S	
Dynamic Characteristics (Note4)	·						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =-50V,V <sub>GS</sub> =0V,	-	3810	-	PF	
Output Capacitance	Coss		-	99	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	94	-	PF	
Switching Characteristics (Note 4)	·						
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD}$ =-50V, $I_{D}$ =-16A $V_{GS}$ =-10V, $R_{GEN}$ =9.1 $\Omega$	-	16	-	nS	
Turn-on Rise Time	t <sub>r</sub>		-	73	-	nS	
Turn-Off Delay Time	$t_{\sf d(off)}$		-	34	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	57	-	nS	
Total Gate Charge	Qg	V <sub>DS</sub> =-50V,I <sub>D</sub> =-16A,	-	70	-	nC	
Gate-Source Charge	Q <sub>gs</sub>		-	12.5	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =-10V	-	15.5	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-10A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is	-	-	-	-18	Α	
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF =-16A	-	88.3	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	65.9	-	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negl	igible (turi	n-on is do	minated b	y LS+LD	

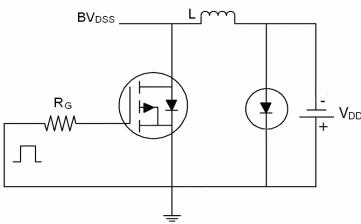
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- $\textbf{4.} \ \textbf{Guaranteed by design}, \ \textbf{not subject to production}$
- **5.** EAS condition: Tj=25  $^{\circ}$ C,V<sub>DD</sub>=-50V,V<sub>G</sub>=-10V,L=0.5mH,Rg=25 $\Omega$

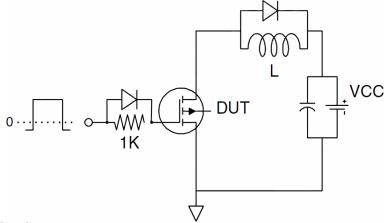


# **Test Circuit**

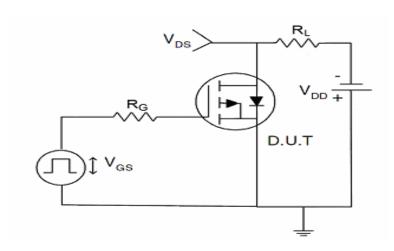
# 1) E<sub>AS</sub> Test Circuit



# 2) Gate Charge Test Circuit

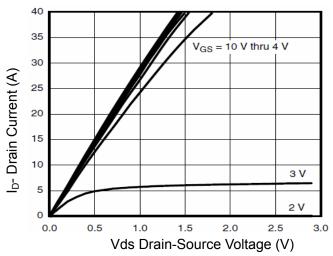


# 3) Switch Time Test Circuit

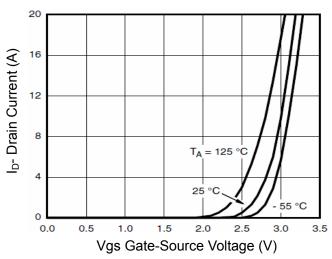




# **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

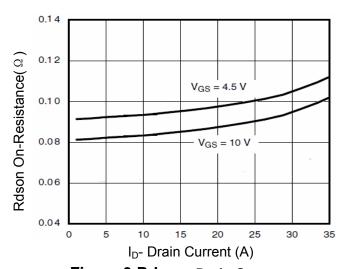


Figure 3 Rdson- Drain Current

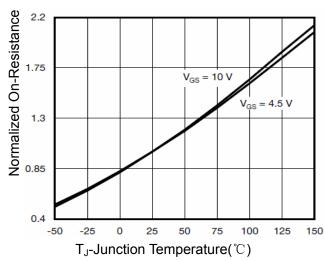


Figure 4 Rdson-JunctionTemperature

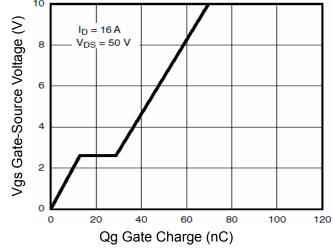


Figure 5 Gate Charge

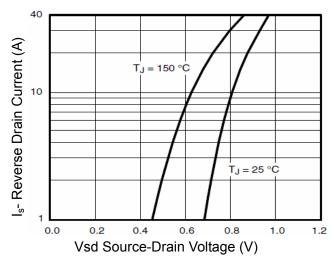


Figure 6 Source- Drain Diode Forward



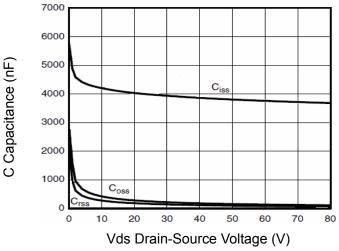
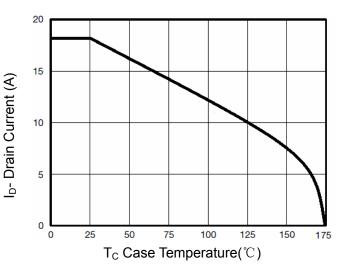
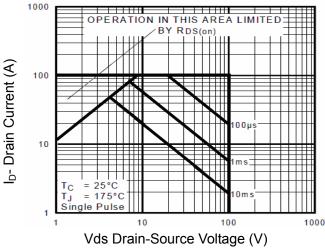


Figure 7 Capacitance vs Vds



**Figure 9 Drain Current vs Case Temperature** 



**Figure 8 Safe Operation Area** 

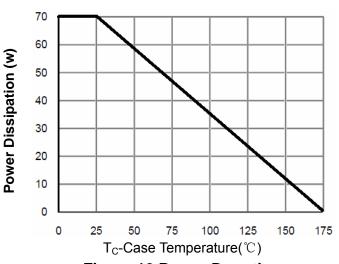
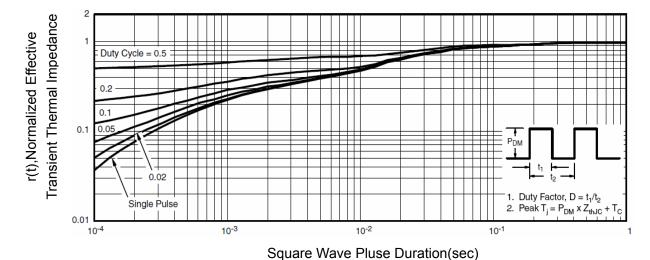


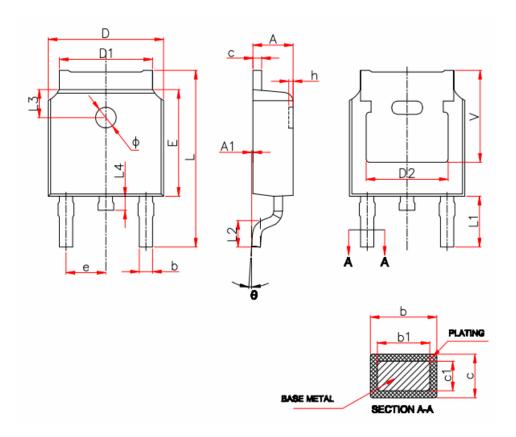
Figure 10 Power De-rating



**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **TO-252 Package Information**



Symbol	Millimeters			
Symbol	Min.	Max.		
Α	2.20	2.40		
A1	0.00	0.13		
b	0.66	0.86		
b1	0.73	0.79		
С	0.46	0.58		
c1	0.50	0.52		
D	6.50	6.70		
D1	5.10	5.46		
D2	4.83 REF.			
Е	6.00	6.20		
е	2.19	2.39		
L	9.80	10.40		
L1	2.90 REF.			
L2	1.40	1.70		
L3	1.60 REF.			
L4	0.60	1.00		
Ф	1.10	1.30		
θ	0°	8°		



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